IPC - ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Form Type *	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					als and Mfg	Informati	on		
upplier Inform	ation								,						
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi											2022-02-10				
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*					
Product-Env-Stewa	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Represe	ntative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requeste	er Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	N	Manufacturing Site		eight*	UOM	Unit Type	
	FDN8601 FET 100V 109.0 mC		Ohm SSOT3		2022-02-10		MY1		10	.813	mg	Each			
	Process Informatio		arminal Paga	Alloy	STD-020 MSL	Pating	Dook Prog	aca Pody T	'amparatur	May Time at Peak	Tomporotur	n Numb	er of Reflow Cyc	Jac	
		Terminal Base Alloy J-STD-02 CU Alloy 1		S1D-020 MSL	Rating	260	Peak Process Body Temperat					er of Reflow Cyc	ries		
•	n (Sn) - annealed	C	U Alloy	1			200		<u>IC</u>	30	seconds	3			
omments	ime of neals townson-t	duning c-1	domina ia 10-1	10 seconds											
	ime at peak temperature														
r more informatio	on regarding material co	mposition p	please refer to	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.283	mg	Supplier	Silicon (Si)	7440-21-3		0.283	mg
Die Attach	0.054	•	Supplier	Silver (Ag)	7440-22-4		0.0429	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0111	mg
Lead Frame	3.684	mg	Supplier	Zinc (Zn)	7440-66-6		0.005	mg
			Supplier	Iron (Fe)	7439-89-6		0.088	mg
			Supplier	Copper (Cu)	7440-50-8		3.59	mg
			Supplier	Phosphorus (P)	7723-14-0		0.001	mg
Mold Compound-Black	6.41		Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.859	mg
			Supplier	Carbon Black (C)	1333-86-4		0.064	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.487	mg
Plating	0.306	mg	Supplier	Tin (Sn)	7440-31-5		0.306	mg
Wire Bond - Au	0.076	mg	Supplier	Gold (Au)	7440-57-5		0.076	mg